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Response Under 37 CFR 1.116  
**EXPEDITED PROCEDURE**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Confirmation No: 7626

Applicant : Hung-Chang Hsieh  
Application No. : 10/691,641  
Filed : October 24, 2003  
Title : HEAT-DISSIPATING FAN MODULE OF ELECTRONIC APPARATUS

TC/A.U. : 2835  
Examiner : CHERVINSKY, BORIS LEO

Attorney Docket No. : HSIE3038/EM  
Customer No. : 23364

**AMENDMENT AND RESPONSE**

Honorable Commissioner for Patents  
P.O. BOX 1450  
Alexandria, VA 22313-1450

Sir:

This paper is in response to the Office Action mailed March 28, 2005 in connection with the above-identified application. Reconsideration of the application is requested in view of the amendments and the remarks that follow. All claim amendments are made without prejudice or disclaimer.

Please amend the application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this letter.

Remarks begin on page 3 of this letter.

*do not enter  
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(M)*